

FDH/FDLL 300/A / 333





LL-34
THE PLACEMENT OF THE EXPANSION GAP
HAS NO RELATIONSHIP TO THE LOCATION
OF THE CATHODE TERMINAL

COLOR BAND MARKING <u>DEVICE 1ST BAND 2ND BAND</u>

FDLL300 BROWN GREEN FDLL300A BROWN YELLOW FDLL333 BROWN BLUE

High Conductance Low Leakage Diode

Sourced from Process 1M. See MMBD1501/A-1505/A for characteristics.

Absolute Maximum Ratings*

TA = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
W _{IV}	Working Inverse Voltage	125	V
Io	Average Rectified Current	200	mA
I _F	DC Forward Current	500	mA
i _f	Recurrent Peak Forward Current	600	mA
i _{f(surge)}	Peak Forward Surge Current Pulse width = 1.0 second Pulse width = 1.0 microsecond	1.0 4.0	A A
T _{stg}	Storage Temperature Range	-65 to +200	°C
T _J	Operating Junction Temperature	175	°C

^{*}These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

NOTES

- 1) These ratings are based on a maximum junction temperature of 200 degrees C.
- 2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

Thermal Characteristics

TA = 25°C unless otherwise noted

Symbol	Characteristic	Max	Units
		FDH/FDLL 300/A / 333	
P_{D}	Total Device Dissipation	500	mW
	Derate above 25°C	3.33	mW/°C
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	300	°C/W

High Conductance Low Leakage Diode (continued)

Electrical Characteristics

TA = 25°C unless otherwise noted

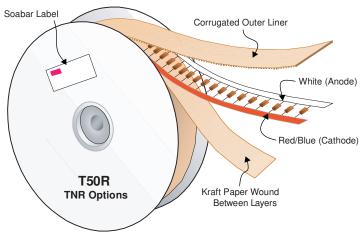
Symbol	Parar	neter	Test Conditions	Min	Max	Units
B _V	Breakdown Voltage)	$I_R = 100 \mu A$	150		V
I _R	Reverse Current	FDH/FDLL 300/A	V _R = 125 V		1.0	nA
			V _B = 125 V, T _A = 150°C		3.0	μΑ
		FDH/FDLL 333	V _B = 125 V		3.0	nA
			V _R = 125 V, T _A = 100°C		500	nA
V _F	Forward Voltage	FDH/FDLL 300/A	I _F = 1.0 mA		680	mV
		FDH/FDLL 300	$I_{\rm F} = 5.0 \text{mA}$		750	mV
		FDH/FDLL 300A	$I_F = 5.0 \text{ mA}$		760	mV
		FDH/FDLL 300/A	$I_F = 10 \text{ mA}$		800	mV
		FDH/FDLL 300	$I_F = 50 \text{ mA}$		880	mV
		FDH/FDLL 300A	$I_F = 50 \text{ mA}$		890	mV
		FDH/FDLL 300/A	$I_F = 100 \text{ mA}$		920	mV
		FDH/FDLL 300/A	$I_F = 200 \text{ mA}$		1.0	V
		FDH/FDLL 333	I _F = 50 mA	800	890	mV
			I _F = 100 mA	830	940	mV
			I _F = 150 mA	860	970	mV
			I _F = 200 mA	0.87	1.05	V
			I _F = 250 mA	0.88	1.08	V
			$I_F = 300 \text{ mA}$	0.9	1.15	V
Co	Diode Capacitance		$V_R = 0, f = 1.0 \text{ MHz}$		6.0	pF

DO-35 Tape and Reel Data



DO-35 Packaging

Configuration: Figure 1.0



DO-35 Packaging

Information Table: Figure 2.0

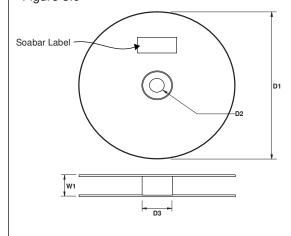
DO-35 Packaging Information							
Packaging Option	T50R	T50A	Standard (no flow code)				
Packaging type	TNR	Ammo	Bag				
Qty per Reel/Tube/Bag	10,000	5,000	500				
Reel Size (inch diameter)	13	-					
Inside Tape Spacing (mm)	52	52	-				
Int Box Dimension (mm)	254x79x794	406x267x184	279x133x108				
Max qty per Box	30,000	50,000	5,000				
Weight per unit (gm)	0.137	0.137	0.137				
Weight per Reel/Ammo (kg)	2.23	0.800	-				
Note/Comments			Bulk				

Soabar Label sample

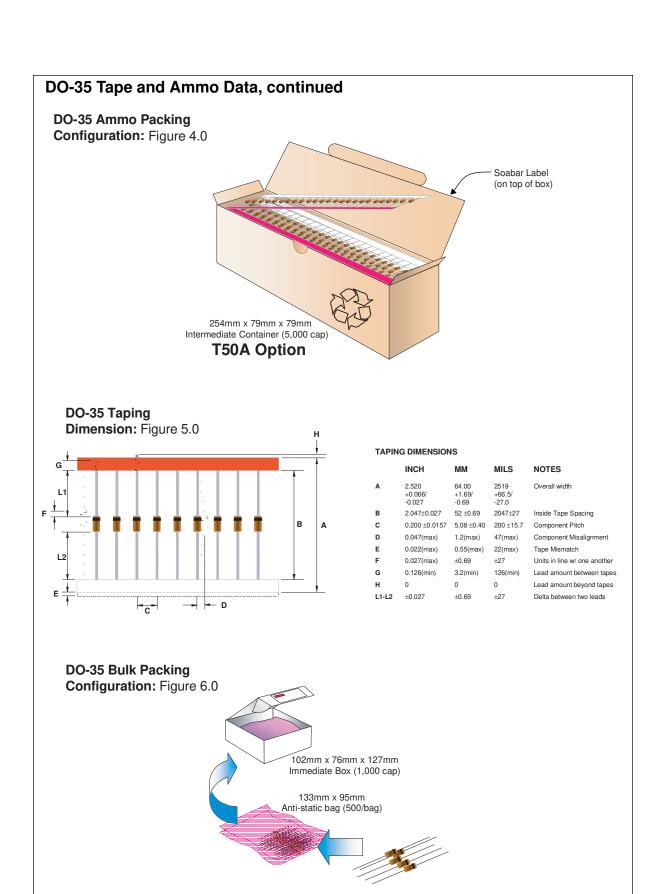
FAIR	CHILD			
SEMICO	NDUCTOR.	P.O. No.		
TYPE	IN5225A	MARK	BLK-BRN	
REV	A2	PART No.		
PKG		EC No.		
QTY	10,000	M.O. No.	OX5046F035	
Q.C.		DATE	D9903	
MFD. UNI	DER US PAT 3.025	.589 & OTHER US PATS & A	PPLICATIONS	

DO-35 Reel Dimensions:

Figure 3.0



REEL DIMENSIONS			
ITEM DESCRIPTION	SYMBOL	MINIMUM	MAXIMUM
Reel Diameter	D1	10.375	10.625
Arbor Hole Diameter (Standard)	D2	1.245	1.255
Core Diameter	D3	3.190	3.310
Flange to Flange Inner Width	W1		3.400
Note: All Dimensions are in inches			

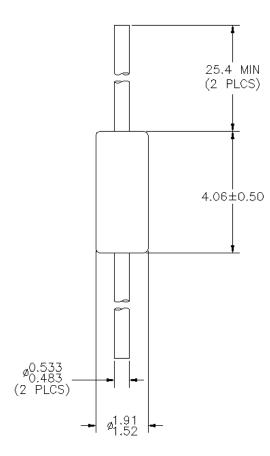


DO-35 Package Dimensions



DO-35 (FS PKG Code D2)



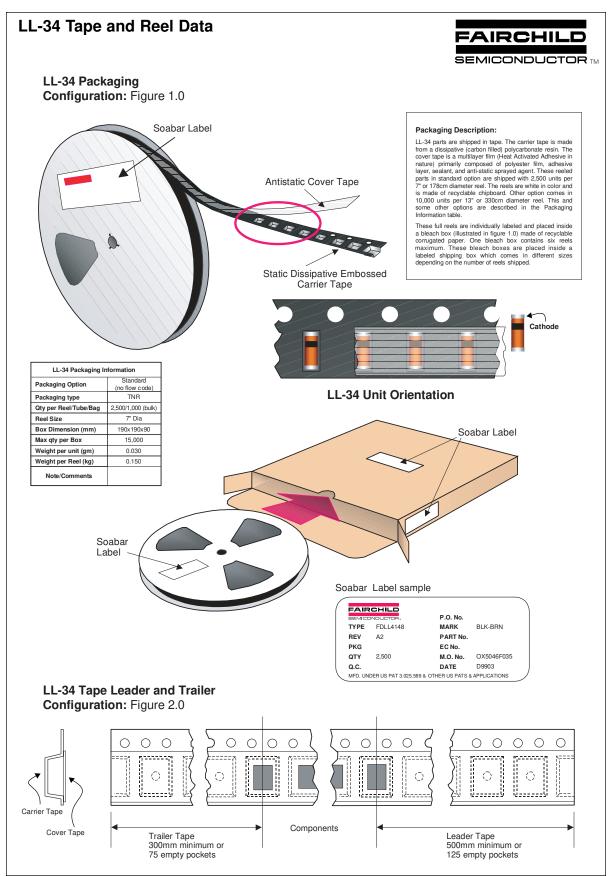




Scale 1:1 on letter size paper
Dimensions shown below are in millimeters
Part Weight per unit (gram): 0.137

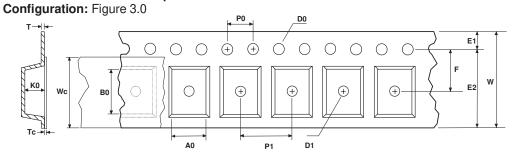
NOTES: UNLESS OTHERWISE SPECIFIED

- A) THIS PACKAGE CONFORMS TO JEDEC D0-204, VAR. AH. ISSUE B. DATED JANUARY 20, 1976.
- B) HERMITICALLY SEALED GLASS PACKAGE



LL-34 Tape and Reel Data, continued

LL-34 Embossed Carrier Tape



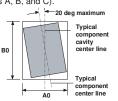
User Direction of Feed

	Dimensions are in millimeter													
Pkg type	Α0	В0	w	D0	D1	E1	E2	F	P1	P0	K0	Т	Wc	Тс
LL-34 (8mm)	1.7 +/-0.10	3.7 +/-0.10	8.0 +/-0.3	1.5 +/-0.10	1.1 +/-0.10	1.75 +/-0.10	6.25 min	3.50 +/-0.05	4.0 +/-0.1	4.05 +/-0.05	1.7 +/-0.10	0.3 +/-0.05	5.5 +/-0.2	0.10 max

Notes: A0, B0, and K0 dimensions are determined with respect to the EIA/Jedec RS-481 rotational and lateral movement requirements (see sketches A, B, and C).



Sketch A (Side or Front Sectional View)
Component Rotation

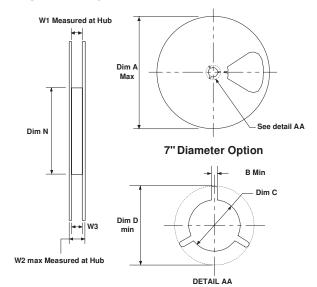


Sketch B (Top View)
Component Rotation



Sketch C (Top View)
Component lateral movement

LL-34 Carton Reel Configuration: Figure 4.0



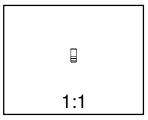
	Dimensions are in inches and millimeters								
Tape Size	Reel Option	Dim A	Dim B	Dim C	Dim D	Dim N	Dim W1	Dim W2	Dim W3 (LSL-USL)
8mm	7" Dia	7.00 178	0.059 1.5	512 +0.020/-0.008 13 +0.5/-0.2	0.795 20.2	2.165 55	0.331 +0.059/-0.000 8.4 +1.5/0	0.567 14.4	0.311 - 0.429 7.9 - 10.9
8mm	13" Dia	13.00 330	0.059 1.5	512 +0.020/-0.008 13 +0.5/-0.2	0.795 20.2	4.00 100	0.331 +0.059/-0.000 8.4 +1.5/0	0.567 14.4	0.311 - 0.429 7.9 - 10.9

LL-34 Package Dimensions

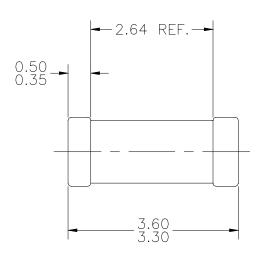


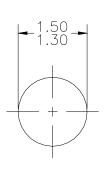
LL-34 (FS PKG Code D3)





Scale 1:1 on letter size paper
Dimensions shown below are in millimeters
Part Weight per unit (gram): 0.030





NOTE: UNLESS OTHERWISE SPECIFIED

- A) THIS PACKAGE CONFORMS TO JEDEC DO-213, VAR AC, ISSUE D, DATED SEPTEMBER 1988.
- B) ALL DIMENSIONS ARE IN MILLIMETERS.

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